

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claims 1-28 (Cancelled).

29. (New) A liquid crystal display device, comprising:
a substrate;
a closed main seal made of a UV hardening sealant on the substrate;
a closed dummy seal made of a UV hardening sealant in a region between the main seal and an edge of the substrate; and
a UV shielding part formed at a location where the dummy seal intersects with a cell-cutting line.

30. (New) The device of claim 29, wherein the UV shielding part is formed under the dummy seal.

31. (New) The device of claim 29, wherein the UV shielding part is formed over the dummy seal.

32. (New) The device of claim 29, wherein the UV shielding part is formed under and over the dummy seal.

33. (New) The device of claim 29, wherein the UV shielding part is formed between the dummy seal and the substrate.

34. (New) The device of claim 29, wherein the UV shielding part is formed at all intersections of the dummy seal and the cell-cutting line.

35. (New) The device of claim 29, wherein the UV shielding part is formed at

intersections of the dummy seal and the cell-cutting line at at least one side edge of the substrate.

36. (New) The device of claim 29, wherein the UV shielding part is formed at intersections of the dummy seal and the cell-cutting line at opposite side edges of the substrate.

37. (New) The device of claim 29, wherein the substrate includes a gate line, a data line, a thin film transistor and a pixel electrode.

38. (New) The device of claim 37, wherein the UV shielding part is formed on the same layer as the gate line.

39. (New) The device of claim 37, wherein the UV shielding part is formed on the same layer as the data line.

40. (New) The device of claim 29, wherein the substrate includes a gate line, a data line, a thin film transistor, a pixel electrode and a common electrode.

41. (New) The device of claim 29, wherein the substrate includes a light-shielding layer, a color filter layer and a common electrode.

42. (New) The device of claim 41, wherein the UV shielding part is formed on the same layer as the light-shielding layer.

43. (New) The device of claim 29, wherein the substrate includes a light-shielding layer and a color filter layer.

44. (New) The device of claim 29, further comprising a column spacer on the substrate.

45. (New) A method for manufacturing an LCD device, comprising:
forming a UV shielding part in a dummy region on one of a first substrate and a second substrate;
forming a closed main seal made of a UV hardening sealant on the substrate on which the

UV shielding part is formed;

forming a closed dummy seal made of a UV hardening sealant on the substrate between the main seal and an edge of the substrate;

applying a liquid crystal on one of the first and second substrates;

attaching the first and second substrates; and

irradiating UV light onto the main seal and dummy seal.

46. (New) The method of claim 45, further comprising cutting the attached substrates into unit cells.

47. (New) The method of claim 45, further comprising:

forming gate and data lines on the first substrate;

forming a thin film transistor at a crossing point of the gate and data lines; and

forming a pixel electrode on the first substrate.

48. (New) The method of claim 47, wherein the UV shielding part is formed with the gate line.

49. (New) The method of claim 47, wherein the UV shielding part is formed with the data line.

50. (New) The method of claim 45, further comprising:

forming a light-shielding layer on the second substrate; and

forming a color filter layer on the light-shielding layer.

51. (New) The method of claim 50, wherein the UV shielding part is formed with the light-shielding layer.

52. (New) The method of claim 45, wherein the UV light is irradiated to the surface of the substrate on which the UV shielding part is formed.

53. (New) The method of claim 45, further comprising heating the attached substrates

after irradiating UV light to the attached substrates.

54. (New) The method of claim 46, wherein cutting the substrates includes scribing and breaking processes in one step.

55. (New) The method of claim 45, wherein irradiating UV light includes masking an active area inside the main seal.

56. (New) The method of claim 45, wherein the main and dummy seals are formed on the second substrate, and the liquid crystal is applied on the first substrate.

57. (New) The method of claim 45, wherein the main and dummy seals are formed on the first substrate, and the liquid crystal is applied on the second substrate.

58. (New) The method of claim 45, further comprising forming a column spacer on one of the first and second substrates.

59. (New) The method of claim 45, wherein the UV shielding part is formed at a location where the dummy seal intersects with a cell-cutting line.